



FOR IMMEDIATE RELEASE

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Lam Research AG Opens New 750-Square-Meter R&D Lab in Villach

VILLACH, Austria, 9 May, 2012 –Semiconductor fabrication equipment supplier Lam Research AG today announced the opening of a new research and development lab in Villach, Austria. The new, state-of-the-art, 750-square-meter facility doubles the site’s R&D capacity and will be used to develop leading-edge technology for customers.

The lab will accommodate wafer cleaning and metrology tools, including Lam’s latest DV-Prime[®] single-wafer spin clean systems, and is built to support next-generation 450 mm tools as well. It is the main component of a multi- million Euro, five-year expansion project announced last year.

Lam Research AG manufactures innovative wet clean systems that are used to remove unwanted materials from semiconductor wafers while also protecting fragile chip structures from damage. Depending on device complexity, these cleaning steps can be repeated more than 100 times during the semiconductor manufacturing process. Lam Research equipment is used by chip manufacturers worldwide for a wide array of semiconductor products used in smartphones, tablets, consumer appliances, and many other applications.

“Today’s lab opening marks a milestone for Lam Research AG and reaffirms our ongoing commitment to develop leading-edge technology solutions for our customers,” said Martin Anstice, president and CEO of Lam Research Corp. “We expect this site to be one of Lam’s most important technology innovation centers.”

Lam Research Villach site vice president and general manager, Jackie Seto, added, “Since October 2010, Lam Research AG has created more than 100 new jobs in Villach. We are excited that as we continue to grow, we will have new opportunities for top local and international engineering graduates and mid-career professionals.”

About Lam Research

Based in Fremont, Calif., USA, Lam Research Corp. (NASDAQ:LRCX) is a major supplier of wafer fabrication equipment and services to the world’s semiconductor industry, where the company has been advancing semiconductor manufacturing for more than 30 years. As a technology and market-share leader in plasma etch and single-wafer clean, Lam Research is leveraging its combined expertise to address some of today’s most advanced semiconductor processing challenges. Lam Research maintains a global network of service facilities throughout North America, Asia, and Europe to meet the complex and changing needs of its global customer base. Lam’s common stock trades on The NASDAQ Global Select MarketSM under the symbol LRCX. Lam Research is a NASDAQ-100[®] company. For more information, visit <http://www.lamresearch.com>.

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Caution Regarding Forward-Looking Statements

Statements made in this press release that are not statements of historical fact are forward-looking statements and are subject to the safe harbor provisions of the Private Securities Litigation Reform Act of 1995. Such forward-looking statements relate, but are not limited, to the scope and progress of the Company’s expansion and renovation project; customer use of the Company’s products; the Company’s business plans and objectives, including its commitment to leading edge technology solutions; our expectations for the new lab to continue as a global technology innovation center, and our expectations for job opportunities and growth. Some factors that may affect these forward-looking statements include: business conditions in the consumer electronics industry, the semiconductor industry and the overall economy; the strength of the financial performance of our existing and prospective customers; the introduction of new and innovative technologies; the occurrence and pace of technology transitions and conversions; the actions of our competitors, consumers, semiconductor companies and key suppliers and subcontractors; and the success of research and development and sales and marketing programs. These forward-looking statements are based on current expectations and are subject to uncertainties and changes in condition, significance, value and effect as well as other risks detailed in documents filed by us with the Securities and Exchange Commission, including specifically our report on Form 10-K for the year ended June 26, 2011 and the reports on Form 10-Q for the three months ended September 25, 2011 December 25, 2011 and March 25, 2012. These uncertainties and changes could cause actual results to vary from expectations. The Company undertakes no obligation to update the information or statements made in this press release.